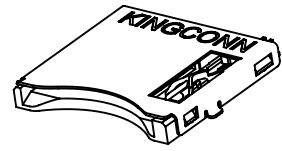


NOTES:
 1. MATERIAL:
 INSULATOR: HIGH TEMPERATURE THERMOPLASTIC,
 UL94V-0, BLACK
 CONTACT: PHOSPHOR BRONZE

2. PART NO: 7TFCN - X 0-0 X 10

PACKING:
 0 TRAY
 1 TAPE&REEL

PLATING:
 F CONTACT AREA PLATING: GOLD FLASH OVER Ni
 SOLDER AREA : Tin PLATING OVER 50μ" Ni
 B CONTACT AREA PLATING: 10μ" GOLD OVER Ni
 SOLDER AREA : Tin PLATING OVER 50μ" Ni



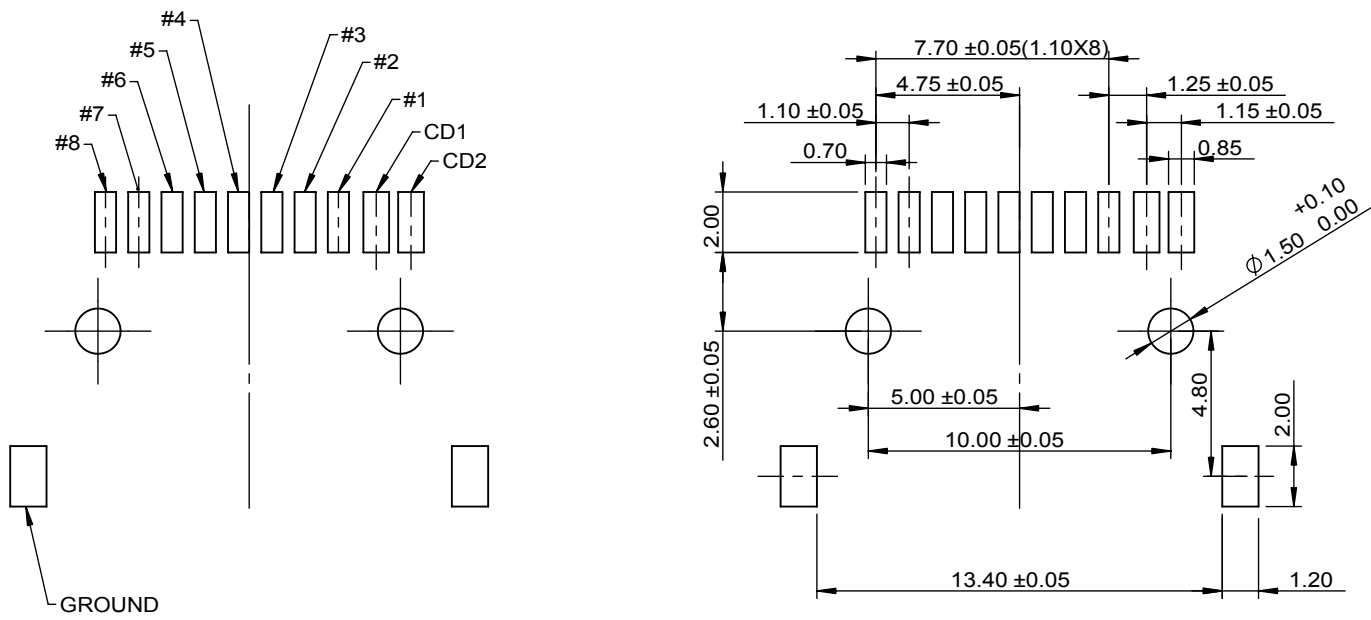
更改 REV	設 變 內 容 MODIFICATION
A	ECN00554
B	ECN00587
C	ECN00674
D	ECN00769
E	ECN00839
F	ECN00955
G	ECN01127
H	ECN02510

GENERAL TOLERANCE	
X ± 0.50	X.° ± 5°
.X ± 0.30	.X.° ± 2°
.XX ± 0.20	.XX.° ± 1°
	.XXX.° ± 0.5°

KINGCONN 皇海科技股份有限公司	
名稱(TITLE) T-Flash & microSD connector	

單位(UNIT) mm	料 號(PART NO.) 7TFCN-X0-0X10	圖 號(DWG NO.) 7TFCN-X0-0X10-H
審 核(APPROVAL)	核 對(CHECKED)	製 圖(DRAWN)
比 例 SCALE 4:1	張 數 SHEET 1 / 3	更 改 REV H

更改 REV	設 變 內 容 MODIFICATION
A	ECN00554
B	ECN00587
C	ECN00674
D	ECN00769
E	ECN00839
F	ECN00955
G	ECN01127
H	ECN02510

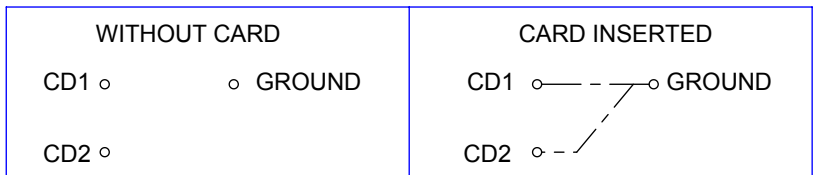


Pin Assignment:

#1	DTA2
#2	CD/DAT3
#3	CMD
#4	VDD
#5	CLK
#6	VSS
#7	DAT0
#8	DAT1

PCB LAYOUT FOR Multi Slot Card Reader

CIRCUIT:



GENERAL TOLERANCE		KINGCONN 皇海科技股份有限公司
X ± 0.50	X ° ± 5 °	
.X ± 0.10	.X ° ± 2 °	
.XX ± 0.05	.XX ° ± 1 °	
.XXX ± 0.5 °		名稱(TITLE) T-Flash & microSD connector
單位(UNIT) mm	料 號(PART NO.) 7TFCN-X0-0X10	圖 號(DWG NO.) 7TFCN-X0-0X10-H
審 核(APPROVAL)	核 對(CHECKED)	製 圖(DRAWN)
比 例 SCALE 4:1	張 數 SHEET 2 / 3	更 改 REV H

